



Material Content Data Sheet



Sales Product Name				2EDF7235K		Issued		9. January 2019	
MA#				MA002245736					
Package				PG-TFLGA-13-1		Weight*		51.03 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip_1	inorganic material	silicon	7440-21-3	0.564	1.11	1.11	11061	11061	
chip_2	inorganic material	silicon	7440-21-3	0.564	1.11	1.11	11061	11061	
chip_3	inorganic material	silicon	7440-21-3	1.097	2.15	2.15	21490	21490	
wire	noble metal	gold	7440-57-5	0.377	0.74	0.74	7390	7390	
encapsulation	organic material	carbon black	1333-86-4	0.307	0.60		6023		
	plastics	epoxy resin	-	2.920	5.72		57214		
	inorganic material	silicondioxide	60676-86-0	27.508	53.88	60.20	539015	602252	
leadfinish	noble metal	gold	7440-57-5	0.126	0.25		2461		
	non noble metal	nickel	7440-02-0	0.143	0.28	0.53	2807	5268	
substrate	plastics	bismaleimide triazine resin	-	1.922	3.77		37659		
	inorganic material	aluminiumhydroxide	21645-51-2	2.114	4.14		41425		
	inorganic material	glass fibre	-	3.652	7.16		71553		
	non noble metal	copper	7440-50-8	5.343	10.47	25.54	104692	255329	
plating	noble metal	gold	7440-57-5	0.638	1.25		12499		
	non noble metal	nickel	7440-02-0	0.727	1.43	2.68	14255	26754	
glue	plastics	epoxy resin	-	0.392	0.77		7684		
	noble metal	silver	7440-22-4	1.176	2.31	3.08	23053	30737	
solder resists	plastics	epoxy resin	-	0.339	0.66		6649		
	inorganic material	bariumsulfate	7727-43-7	0.521	1.02		10202		
	plastics	acrylic resin	-	0.603	1.18	2.86	11807	28658	
*deviation	< 10%			Sum in total:		100.00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com